



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
20V	$0.99\Omega$ @ $V_{GS} = 4.5V$	0.45A
	$1.2\Omega$ @ $V_{GS} = 2.5V$	0.40A
	$1.8\Omega$ @ $V_{GS} = 1.8V$	0.34A
	$2.4\Omega$ @ $V_{GS} = 1.5V$	0.30A

#### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

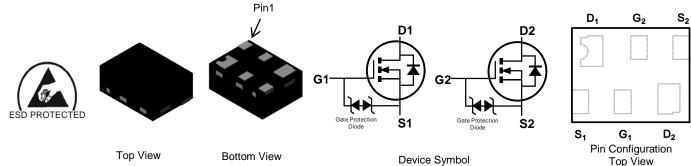
- General Purpose Interfacing Switch
- **Power Management Functions**
- Analog Switch

### **Features and Benefits**

- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Maximum
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 0.8mm x 0.6mm
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: X2-DFN0806-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.001 grams (Approximate)



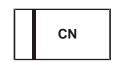
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN2991UDA-7B	X2-DFN0806-6	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

### **Marking Information**



Top View

CN = Product Type Marking Code



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Continuous Drain Current (Note 5)	Steady	T <sub>A</sub> = +25°C	- I <sub>D</sub>	0.45	- A
	State	T <sub>A</sub> = +70°C		0.36	
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	1.2	Α

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

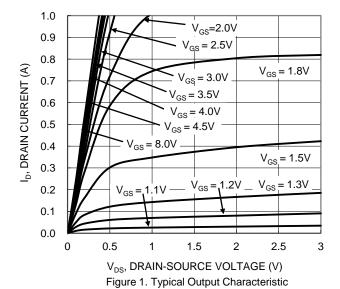
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		$P_{D}$	0.31	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	404	°C/W
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

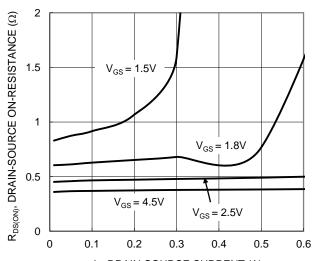
#### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°	C I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μA	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	-						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	0.78	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
		_	0.47	0.99	Ω	$V_{GS} = 4.5V, I_D = 100mA$	
Static Drain-Source On-Resistance	Process	_	0.63	1.2		$V_{GS} = 2.5V, I_D = 50mA$	
Static Drain-Source On-Nesistance	R <sub>DS(ON)</sub>		0.84	1.8	12	$V_{GS} = 1.8V, I_D = 20mA$	
		_	1.1	2.4		$V_{GS} = 1.5V, I_D = 10mA$	
Diode Forward Voltage	$V_{SD}$	_	0.6	1.0	V	$V_{GS} = 0V$ , $I_{S} = 10mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	_	21.5	_	pF	101/1/	
Output Capacitance	Coss	_	4.9	_	pF	$V_{DS} = 16V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	3.7	_	pF	T = 1.0WHZ	
Gate Resistance	Rg	_	0.94	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge	Qg	_	0.35	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Source Charge	Qgs	_	0.07	_	nC	I <sub>D</sub> = 250mA	
Gate-Drain Charge	$Q_{gd}$	_	0.08	_	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.6	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$ $R_{L} = 47\Omega, R_{g} = 10\Omega,$ $I_{D} = 200\text{mA}$	
Turn-On Rise Time	t <sub>R</sub>	_	4.9	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	60.6	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	27.6	_	ns		
Reverse Recovery Time	t <sub>RR</sub>	_	12.3	_	ns	I <sub>F</sub> = 1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	$Q_{RR}$	_	1.1	_	nC	I <sub>F</sub> = 1.0A, di/dt = 100A/μs	

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Currenteed by decise. Not subject to a self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.







I<sub>D</sub>, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

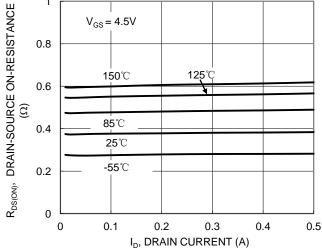
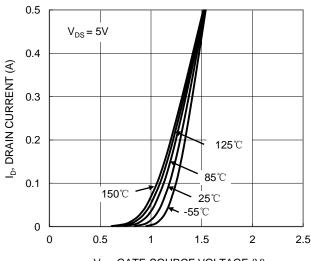


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

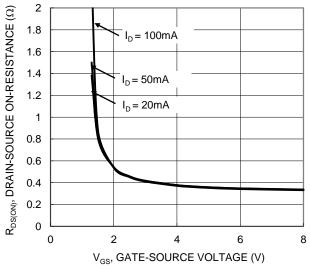


Figure 4. Typical Transfer Characteristic

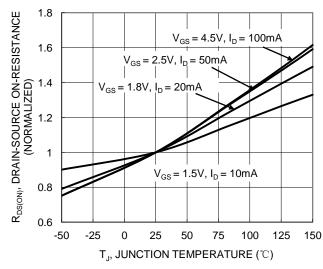


Figure 6. On-Resistance Variation with Temperature



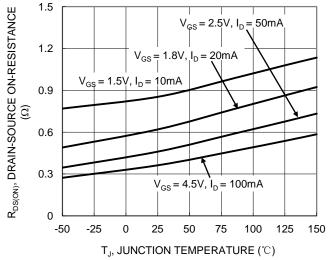


Figure 7. On-Resistance Variation with Temperature

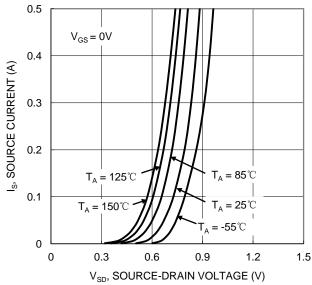


Figure 9. Diode Forward Voltage vs. Current

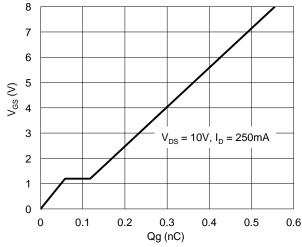


Figure 11. Gate Charge

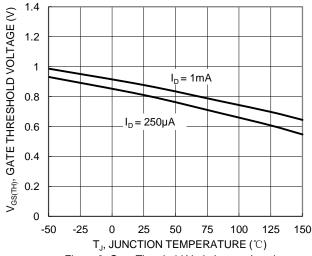


Figure 8. Gate Threshold Variation vs. Junction Temperature

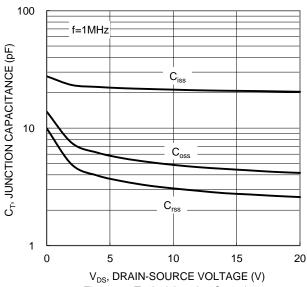


Figure 10. Typical Junction Capacitance

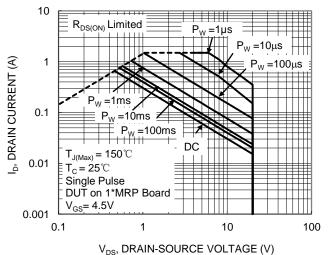


Figure 12. SOA, Safe Operation Area

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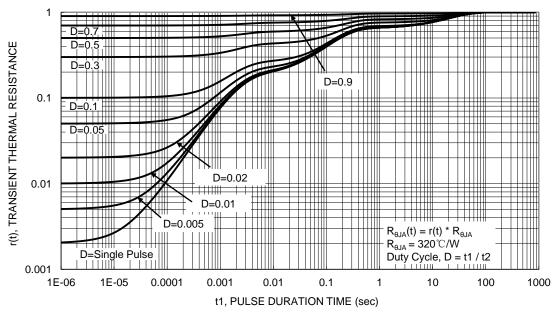


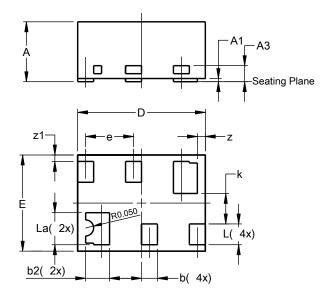
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DFN0806-6

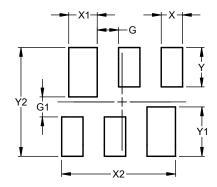


X2-DFN0806-6					
Dim	Min	Max	Тур		
Α		0.40	0.36		
A1	0.00	0.03	0.02		
A3			0.10		
b	0.07	0.15	0.10		
b2	0.10	0.20	0.15		
D	0.75	0.85	0.80		
E	0.55	0.65	0.60		
е			0.30		
k			0.19		
L	0.10	0.18	0.13		
La	0.17	0.25	0.20		
Z			0.05		
z1			0.04		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DFN0806-6



Dimensions	Value (in mm)			
G	0.150			
G1	0.140			
X	0.150			
X1	0.200			
X2	0.800			
Y	0.275			
Y1	0.345			
Y2	0.760			



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